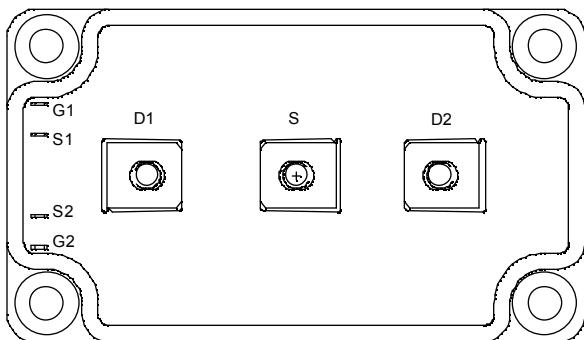
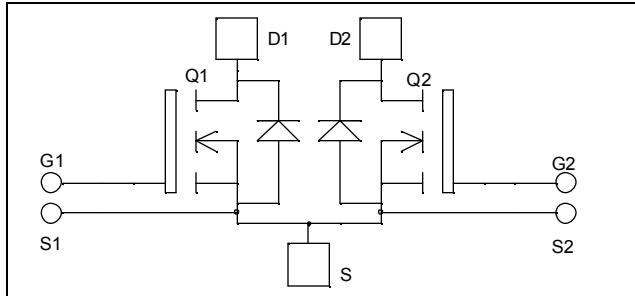


**Dual common source  
MOSFET Power Module**

**V<sub>DSS</sub> = 1200V**  
**R<sub>DSon</sub> = 150mΩ max @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 60A @ T<sub>c</sub> = 25°C**



**Absolute maximum ratings**

Symbol	Parameter	Max ratings	Unit
V <sub>DSS</sub>	Drain - Source Breakdown Voltage	1200	V
I <sub>D</sub>	Continuous Drain Current	T <sub>c</sub> = 25°C	A
		T <sub>c</sub> = 80°C	
I <sub>DM</sub>	Pulsed Drain current	240	
V <sub>GS</sub>	Gate - Source Voltage	±30	V
R <sub>DSon</sub>	Drain - Source ON Resistance	150	mΩ
P <sub>D</sub>	Maximum Power Dissipation	T <sub>c</sub> = 25°C	W
I <sub>AR</sub>	Avalanche current (repetitive and non repetitive)	22	A
E <sub>AR</sub>	Repetitive Avalanche Energy	50	
E <sub>AS</sub>	Single Pulse Avalanche Energy	3000	mJ

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

### Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$\text{BV}_{\text{DSS}}$	Drain - Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 1\text{mA}$		1200			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 1200\text{V}$	$T_j = 25^\circ\text{C}$			400	$\mu\text{A}$
		$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 1000\text{V}$	$T_j = 125^\circ\text{C}$			2000	
$R_{\text{DS(on)}}$	Drain – Source on Resistance	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 30\text{A}$				150	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 10\text{mA}$		3		5	V
$I_{\text{GSS}}$	Gate – Source Leakage Current	$V_{\text{GS}} = \pm 30\text{ V}, V_{\text{DS}} = 0\text{V}$				$\pm 250$	nA

### Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}} = 0\text{V}$ $V_{\text{DS}} = 25\text{V}$ $f = 1\text{MHz}$			20.6		nF
$C_{\text{oss}}$	Output Capacitance				3.08		
$C_{\text{rss}}$	Reverse Transfer Capacitance				0.52		
$Q_g$	Total gate Charge	$V_{\text{GS}} = 10\text{V}$ $V_{\text{Bus}} = 600\text{V}$ $I_{\text{D}} = 60\text{A}$			748		nC
$Q_{\text{gs}}$	Gate – Source Charge				96		
$Q_{\text{gd}}$	Gate – Drain Charge				480		
$T_{\text{d(on)}}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{\text{GS}} = 15\text{V}$ $V_{\text{Bus}} = 800\text{V}$ $I_{\text{D}} = 60\text{A}$ $R_G = 1.2\Omega$			20		ns
$T_r$	Rise Time				15		
$T_{\text{d(off)}}$	Turn-off Delay Time				160		
$T_f$	Fall Time				45		
$E_{\text{on}}$	Turn-on Switching Energy ①	<b>Inductive switching @ 25°C</b> $V_{\text{GS}} = 15\text{V}, V_{\text{Bus}} = 800\text{V}$ $I_{\text{D}} = 60\text{A}, R_G = 1.2\Omega$			3.96		mJ
$E_{\text{off}}$	Turn-off Switching Energy ②				2.74		
$E_{\text{on}}$	Turn-on Switching Energy ①	<b>Inductive switching @ 125°C</b> $V_{\text{GS}} = 15\text{V}, V_{\text{Bus}} = 800\text{V}$ $I_{\text{D}} = 60\text{A}, R_G = 1.2\Omega$			6.26		mJ
$E_{\text{off}}$	Turn-off Switching Energy ②				3.43		

### Source - Drain diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_s$	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$			60	A
			$T_c = 80^\circ\text{C}$			45	
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}} = 0\text{V}, I_s = -60\text{A}$				1.3	V
$dv/dt$	Peak Diode Recovery ③					10	V/ns
$t_{\text{rr}}$	Reverse Recovery Time	$I_s = -60\text{A}, V_R = 600\text{V}$			1291		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$di_s/dt = 400\text{A}/\mu\text{s}$			116		$\mu\text{C}$

①  $E_{\text{on}}$  includes diode reverse recovery.

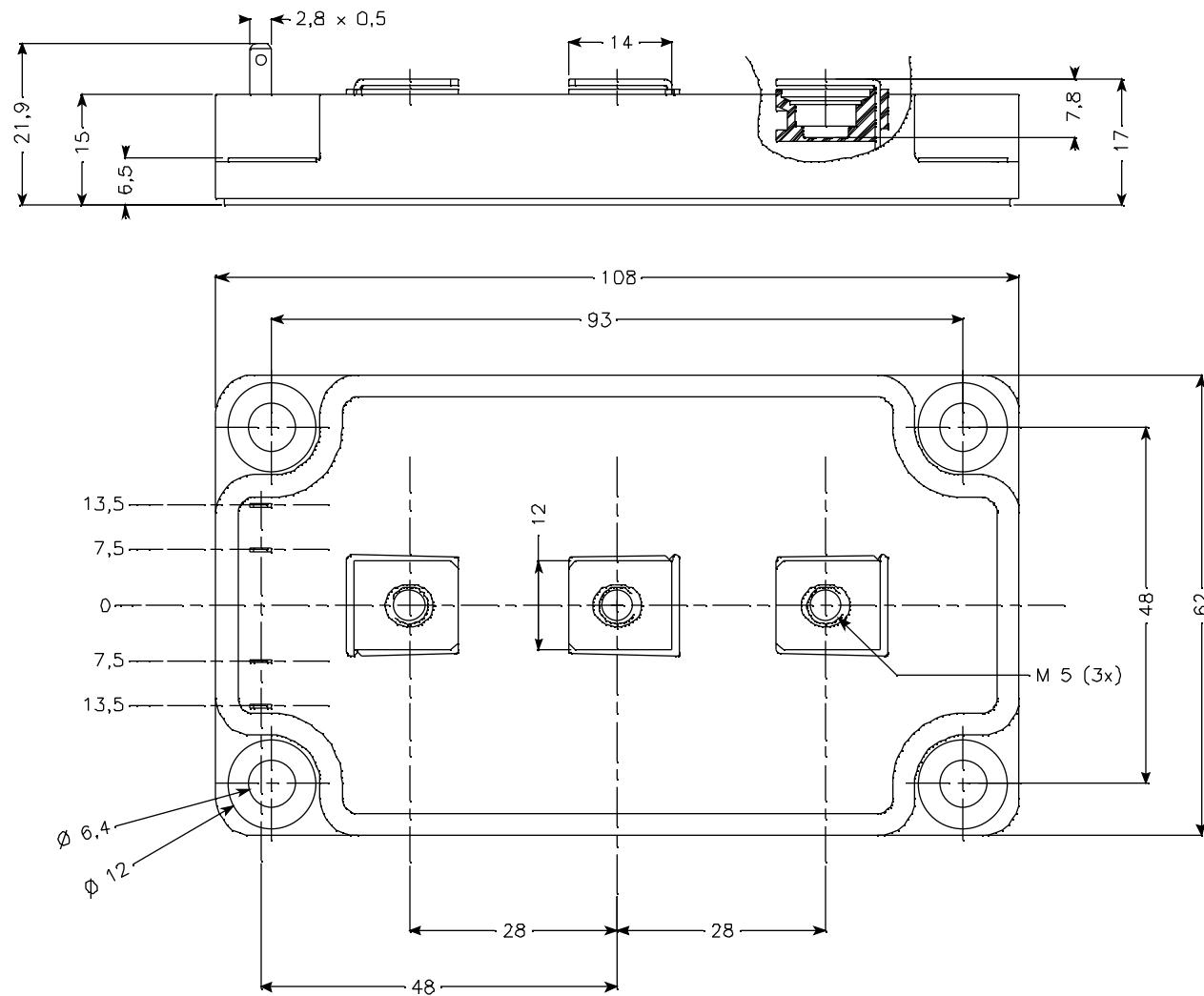
② In accordance with JEDEC standard JESD24-1.

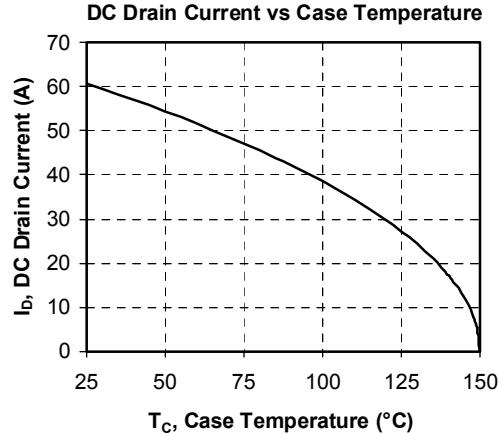
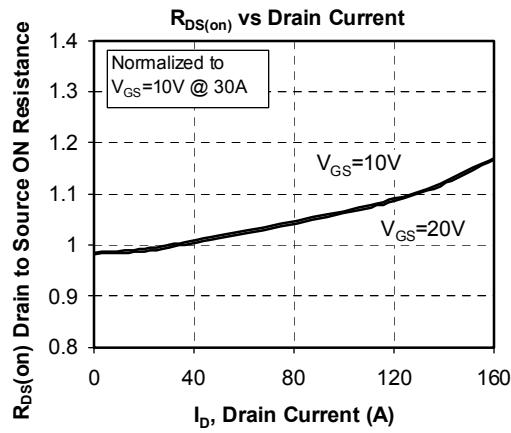
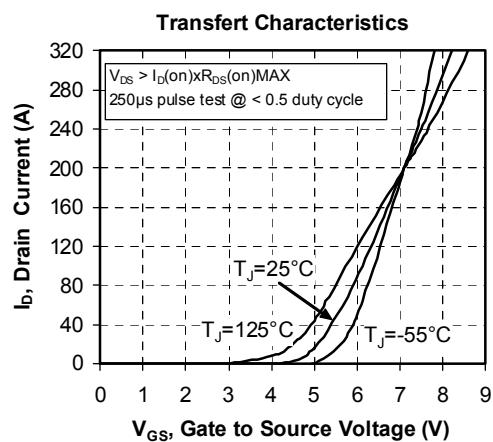
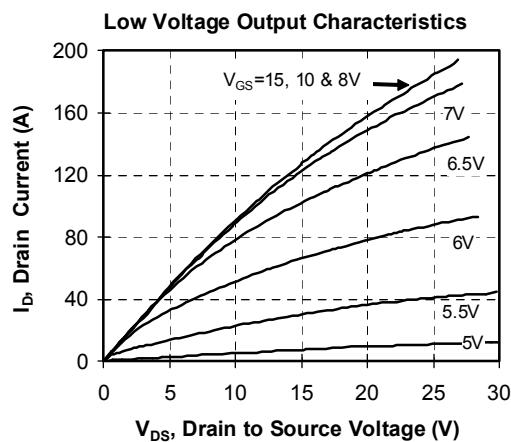
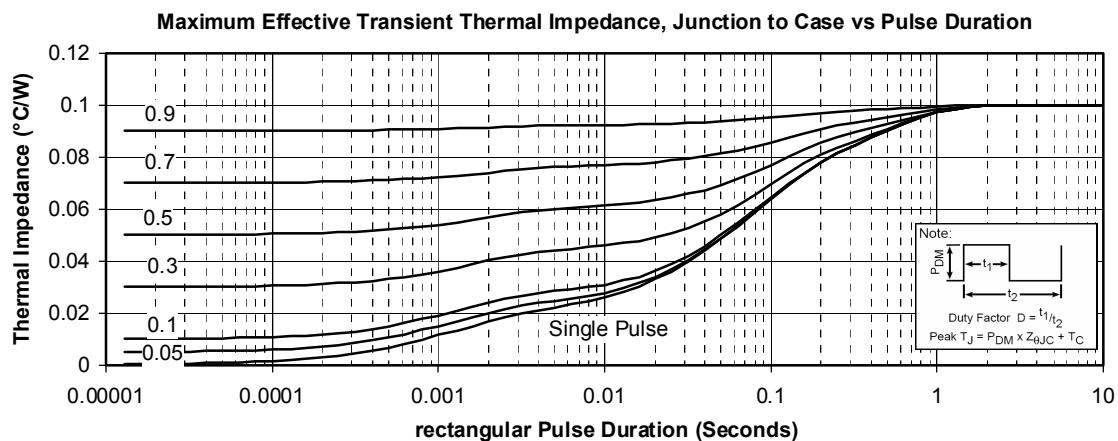
③  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

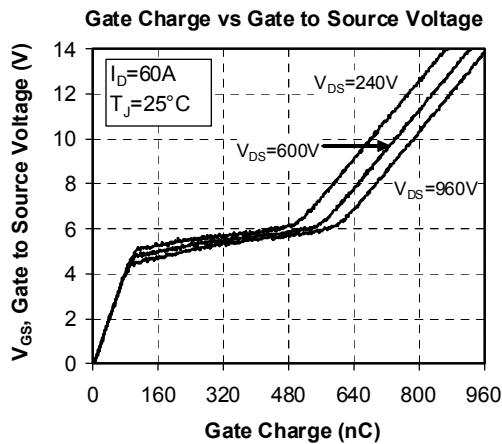
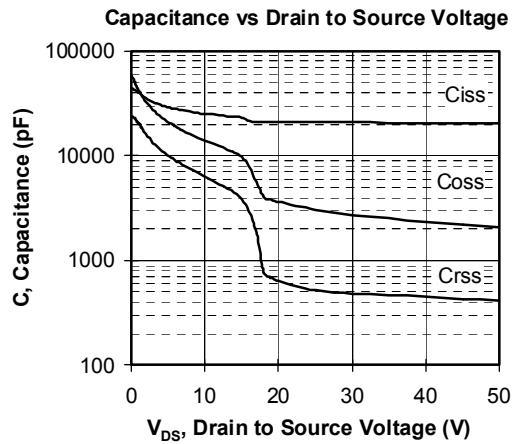
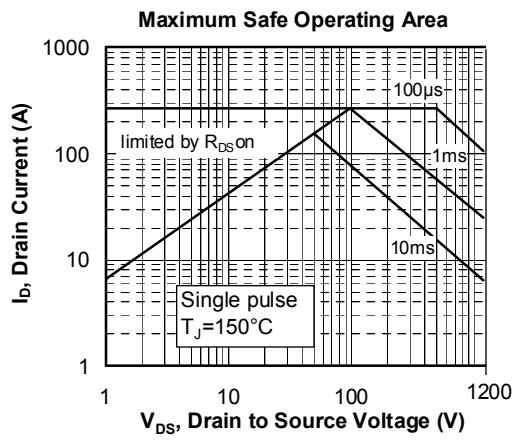
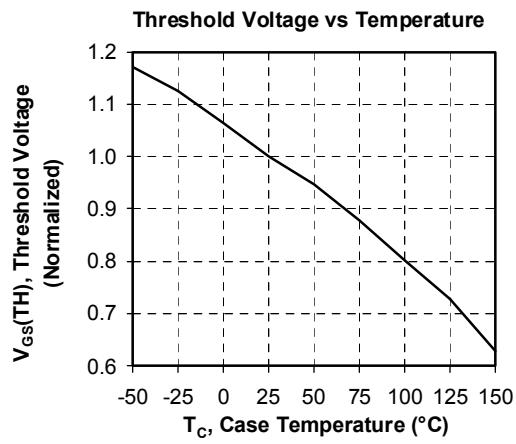
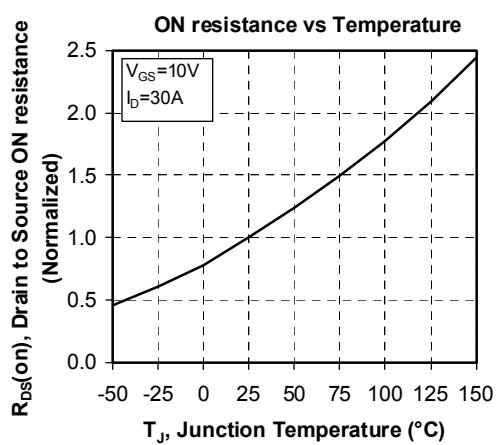
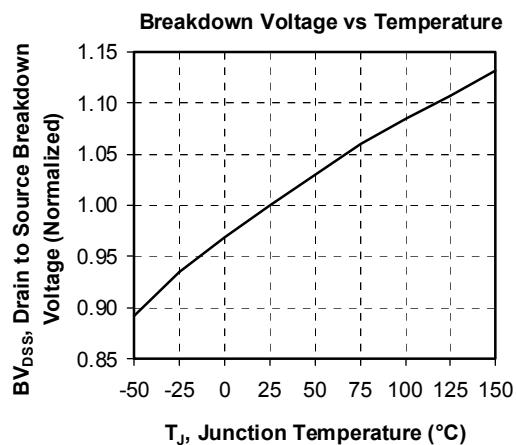
$I_s \leq -60\text{A}$     $di/dt \leq 700\text{A}/\mu\text{s}$     $V_R \leq V_{\text{DSS}}$     $T_j \leq 150^\circ\text{C}$

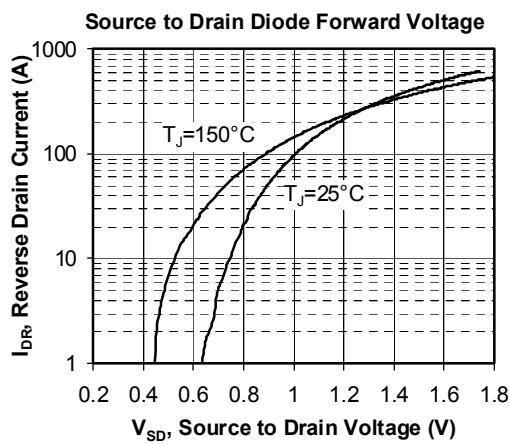
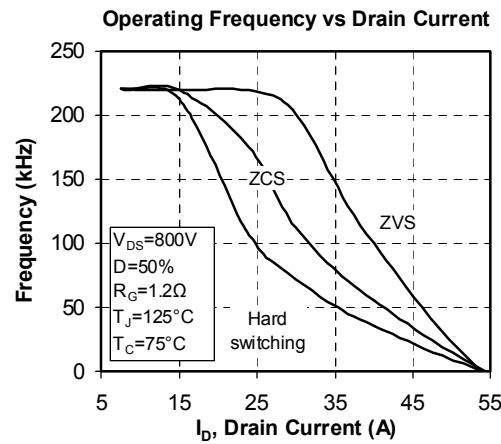
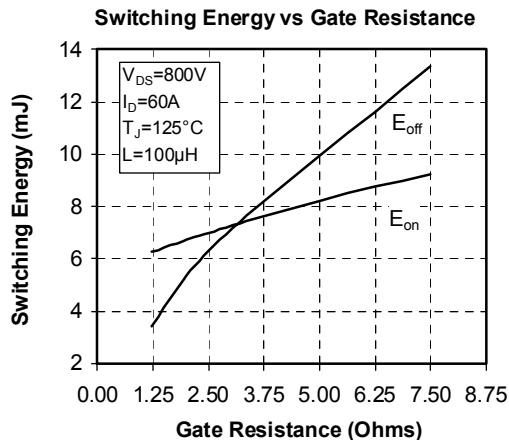
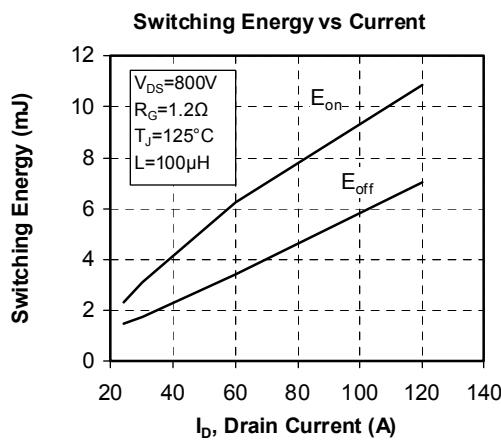
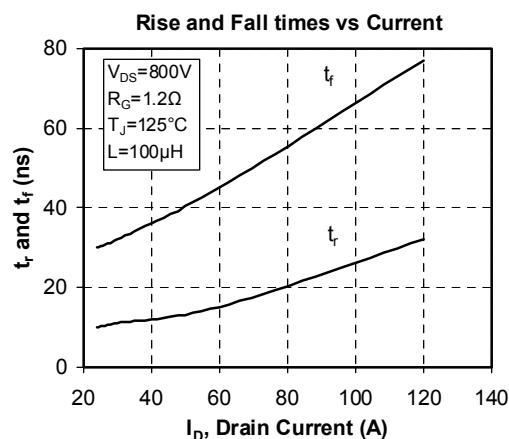
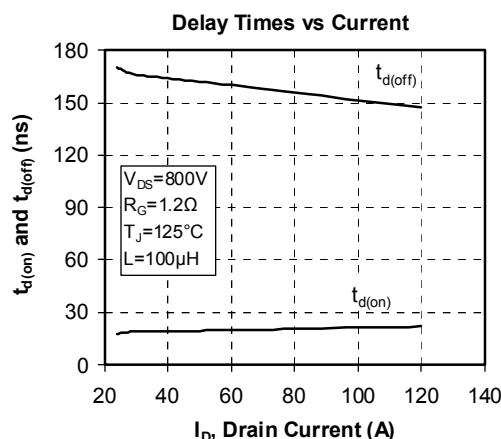
**Thermal and package characteristics**
**Symbol**    **Characteristic**

			<i>Min</i>	<i>Typ</i>	<i>Max</i>	<i>Unit</i>
R <sub>thJC</sub>	Junction to Case				0.1	°C/W
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz	2500				V
T <sub>J</sub>	Operating junction temperature range	-40		150		°C
T <sub>STG</sub>	Storage Temperature Range	-40		125		°C
T <sub>C</sub>	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink For terminals	M6 M5	3 2	5 3.5	N.m
Wt	Package Weight				280	g

**Package outline**


**Typical Performance Curve**






APT reserves the right to change, without notice, the specifications and information contained herein

APT's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.